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DATA SHEET

PART NO.: L-T650WDT-WW-U1

REV: A / 0

CUSTOMER'S APPROVAL: _____

DCC: _____

DRAWING NO.: DS-31P-19-0135

DATE: 2019-07-25

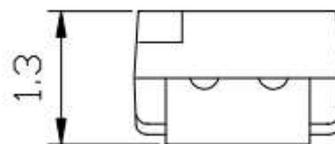
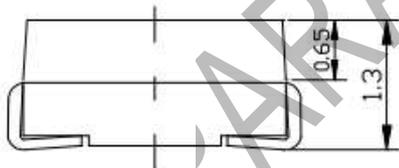
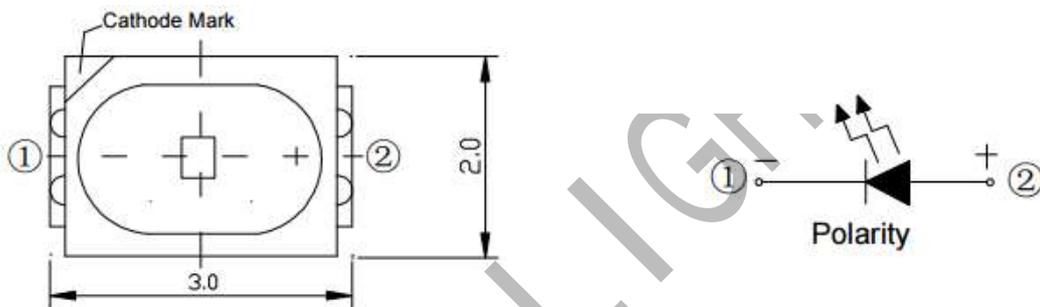
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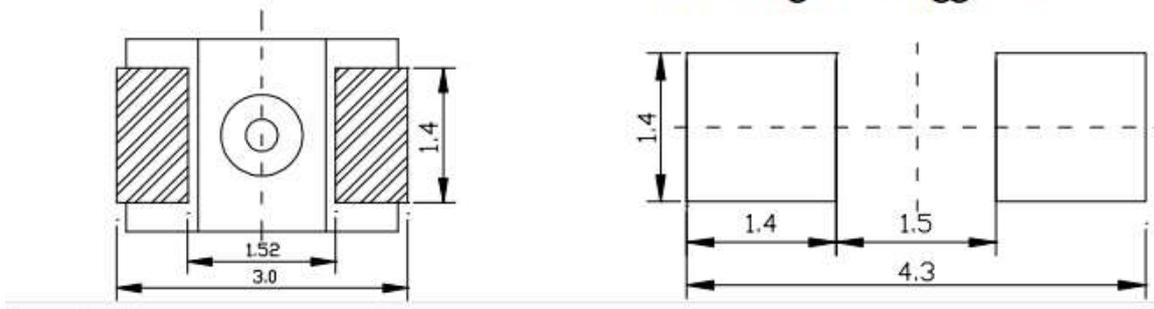
■ Features

- *Color : Ultra Bright Standard White
- *Lens: Yellow Diffuse Flat Mold
- *EIA STD Package
- *Meet ROHS, Green Product
- *Compatible With SMT Automatic Equipment
- *Compatible With Infrared Reflow Solder And Wave Solder Process

■ Package Dimensions



Soldering PAD Suggested:



Notes:

1. All dimensions are in millimeters.
2. Tolerances are ± 0.1 mm unless otherwise note



SURFACE MOUNT DEVICE LED

Part No.:L-T650WDT-WW-U1

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■ Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Unit
Forward Current	IF	20	mA
Reverse Voltage	VR	5	V
Power Dissipation	Pd	80	mW
Peak Forward Current	IFP	100	mA
Operating Temperature	Topr	-30~ +85	°C
Storage Temperature	Tstg	-40~ +90	°C
Welding temperature	Tsol	Reflow soldering : 260 °C for 5 sec. Hand soldering: 300°C for 3 sec.	

■ Electrical - Optical Characteristics (Ta =25°C)

Product model	Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
L-T650WDT-WW-U1	Luminous Intensity	IV	IF=20mA	7		8	lm
	Forward Voltage	VF	IF=20mA	2.8		3.2	V
	Color Temperature	TC	IF=20mA	2600		3400	LM
	Viewing Angle	2θ1/2	IF=20mA		120		Deg
	Reverse Current	IR	Vr=5V			10	uA

Typical electro-optical characteristics curves

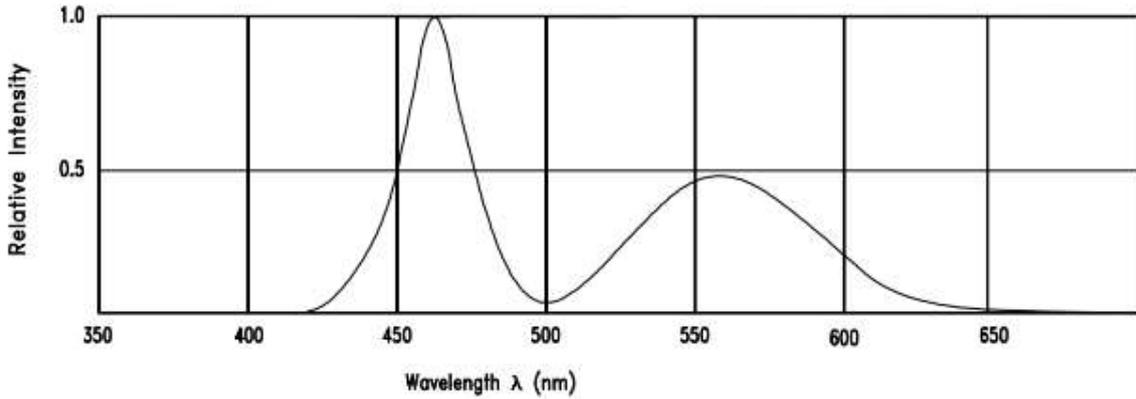


Fig.1 Relative Intensity vs. Wavelength

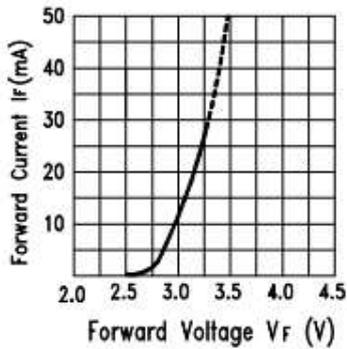


Fig.2 Forward Current vs. Forward Voltage

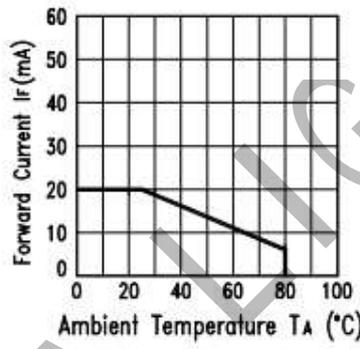


Fig.3 Forward Current Derating Curve

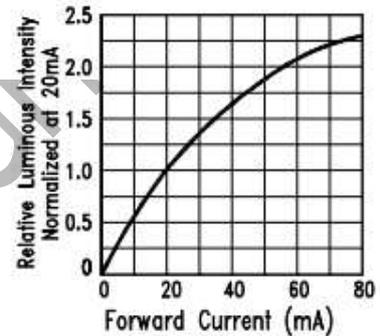


Fig.4 Relative Luminous Intensity vs. Forward Current

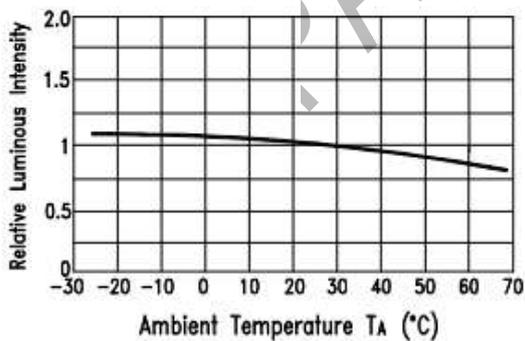


Fig.5 Luminous Intensity vs. Ambient Temperature

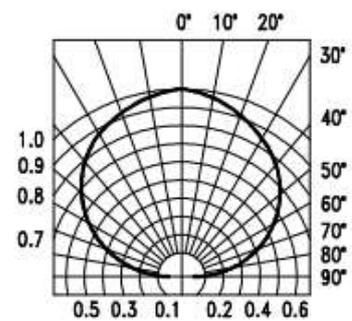


Fig.6 Spatial Distribution

Warm White Color coordinate

BIN	X	Y	BIN	X	Y
B6-2	0.414	0.389	B6-3	0.425	0.4
	0.425	0.4		0.437	0.412
	0.432	0.383		0.444	0.395
	0.421	0.372		0.432	0.383
BIN	X	Y	BIN	X	Y
B6-4	0.437	0.412	B6-5	0.448	0.423
	0.448	0.423		0.46	0.435
	0.455	0.406		0.467	0.418
	0.444	0.395		0.455	0.406

Label Explanation Explanation Explanation

CAT : Luminous Intensity Rank (unit : mcd)

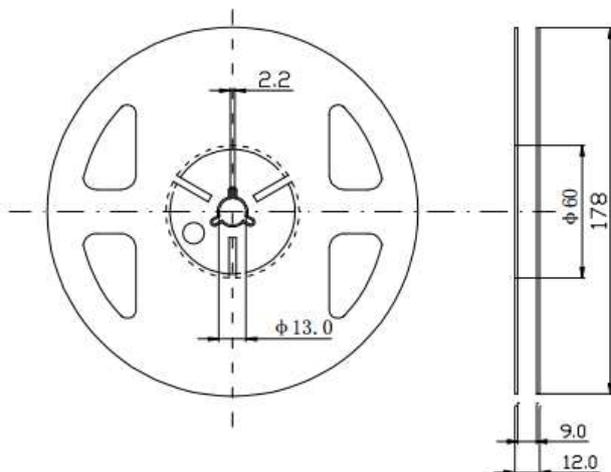
HUE : CIE 1931 Coordinate Rank REF :

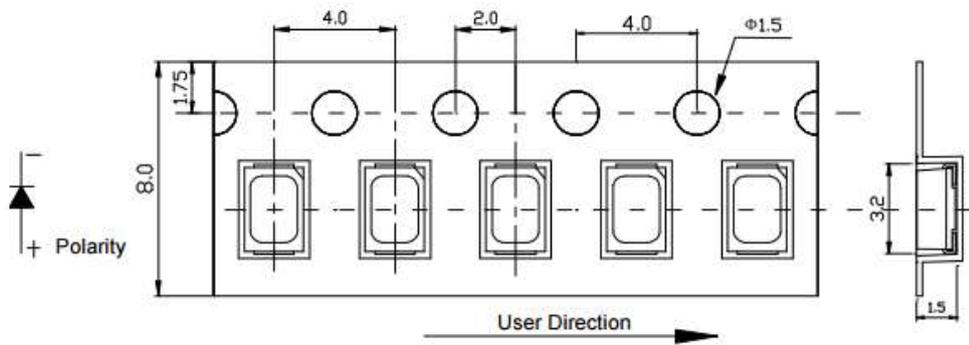
Forward Voltage Rank (unit : V)

Rank Tolerance:

- a. Luminous Intensity: $\pm 15\%$
- b. HUE: ± 0.01
- c. Forward Voltage: $\pm 0.1V$

Reel And Tape Dimensions :

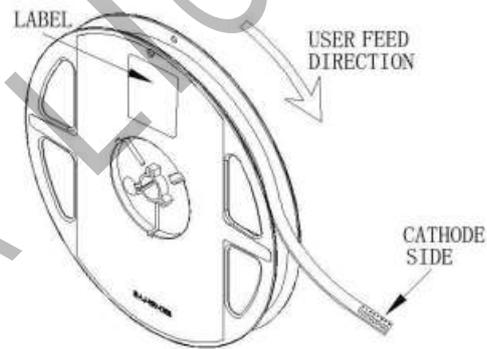
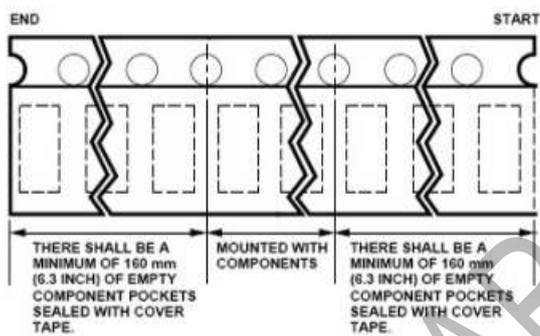




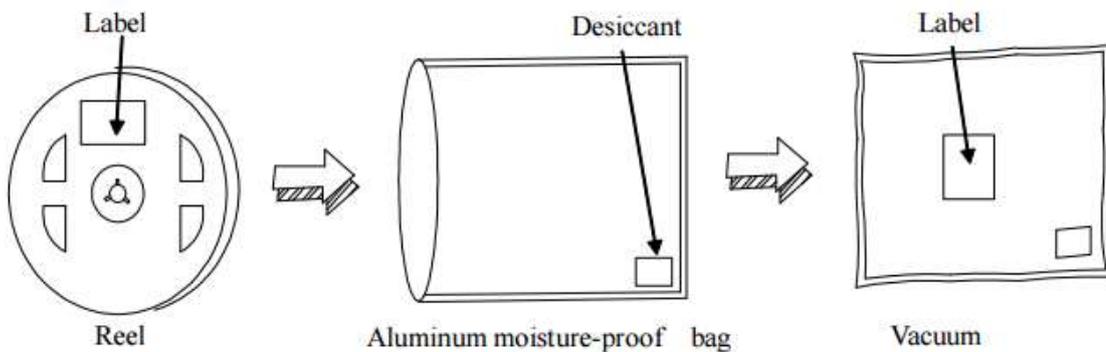
Notes:

1. All dimensions are in millimeters ;
2. Tolerance is ± 0.1 mm unless otherwise noted.

Tape Leader & Trailer Dimensions And Reel



Packaging :





SURFACE MOUNT DEVICE LED

Part No.:L-T650WDT-WW-U1

REV:A / 0

Label:



Reliability Test

Classification	Test Item	Test Condition	Reference Standard	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS, +72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C, RH= 90~95%	240HRS ± 2HRS	MIL-STD-202F:103B JIS C 7021:B-11
	High Temperature Storage	Ta= 105±5°C	1000HRS (-24HRS, +72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5°C	1000HRS (-24HRS, +72HRS)	JIS C 7021:B-12



SURFACE MOUNT DEVICE LED

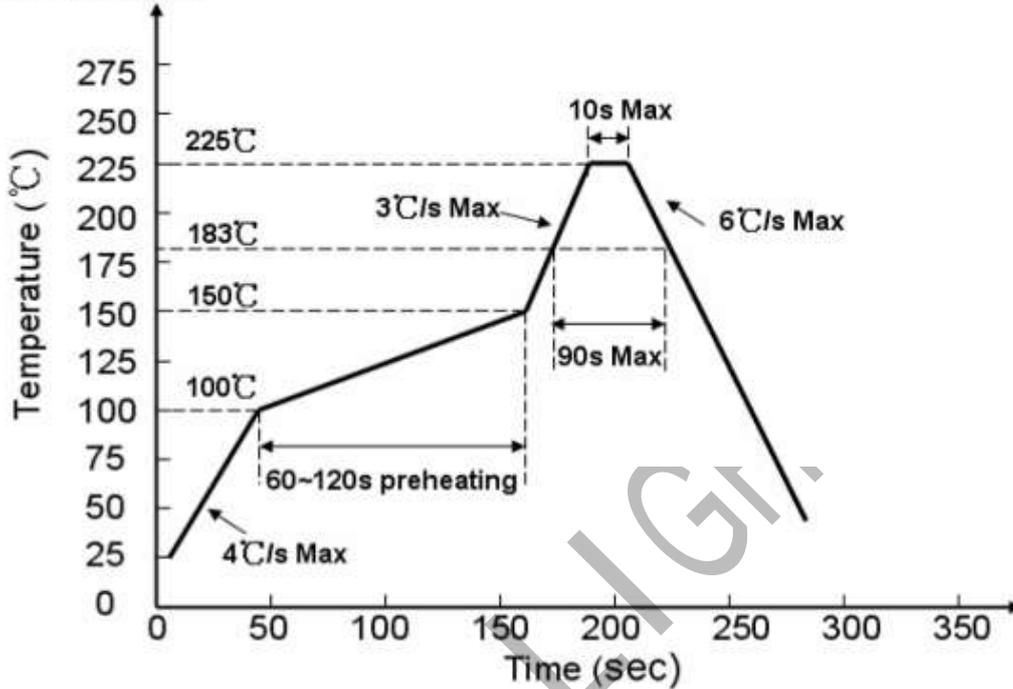
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REV:A / 0

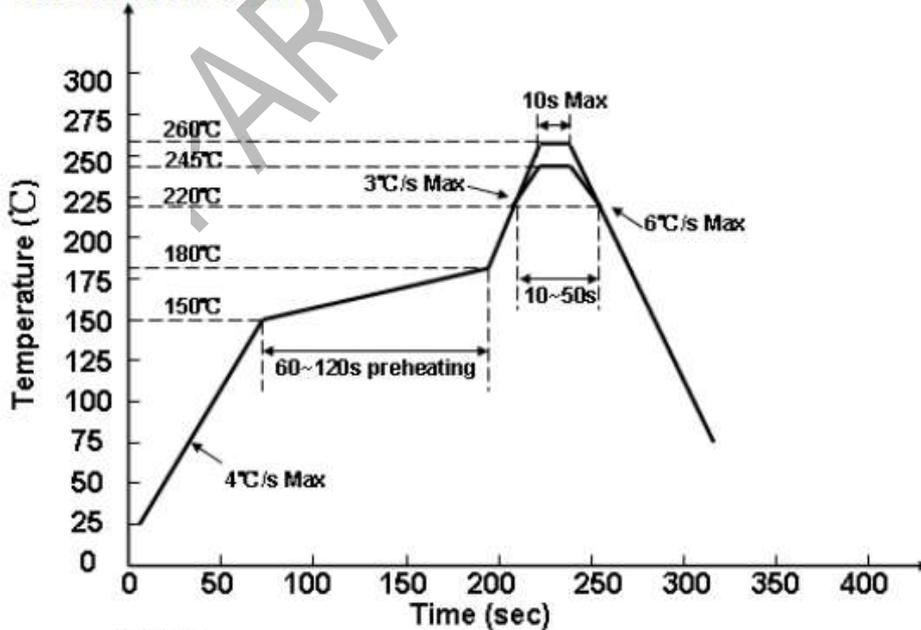
Environmental Test	Temperature Cycling	105°C ~ 25°C ~ -55°C ~ 25°C 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	IR-Reflow In-Board, 2 Times 85 ± 5°C ~ -40°C ± 5°C 10mins 10mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	T. sol= 260 ± 5°C	10 ± 1secs	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
	IR-Reflow Normal Process	Ramp-up rate(183°C to Peak) +3°C/ second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C +5/-0°C Time within 5° C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175(±25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C +0/-5°C Time within 5° C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6°C/second max		
	Solderability	T. sol= 235 ± 5°C Immersion rate 25±2.5 mm/sec Coverage ≧95% of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

Soldering Profile Suggested

For Lead Solder



For Lead Free Solder

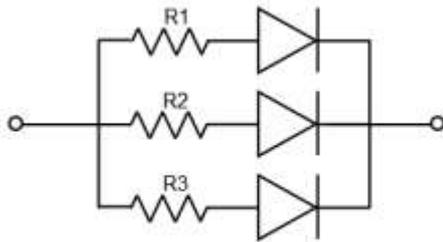
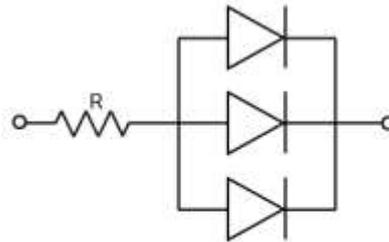


Notes:

We recommend the soldering temperature $245 \pm 5^\circ\text{C}$;
 The maximum temperature should be limited to 260°C .

Application

1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.

**Circuit model A****Circuit model B**

3. High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

Storage

1. Before opening original package, it is recommended to store them in the following environment:
Temperature: 5°C~30°C Humidity: 85%RH max.
2. After opening original package, the storage ambient for the LEDs should be in 5~30 °C temperature and 60% or less relative humidity.
3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
4. The LEDs should be used within 168hrs (7 days) after opening the package. Once been mounted, soldering should be quick.
5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7 days), baking treatment should be performed using the conditions: 60°C at least 24 hours



SURFACE MOUNT DEVICE LED

Part No.:L-T650WDT-WW-U1

REV: A / 0

ESD (Electrostatic Discharge)-Protection

A LED (especially the Blue 、 White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no light-up” at low currents, etc. Some advice as below should be noticed:

1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.
2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded.
3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
4. Use ionizer to neutralize the static charge during handling or operating.
5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

Cleaning

alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary

Soldering

1. Soldering condition refer to the draft “Soldering Profile Suggested” on page 1.
2. Reflow soldering should not be done more than 2 times.
 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300 °C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
 4. During the soldering process, do not touch the lens at high temperature.
 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

Others

1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Harvatek’s Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).



SURFACE MOUNT DEVICE LED

Part No.:L-T650WDT-WW-U1

REV: A / 0

2.light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.

3. The appearance and specifications of the product may be modified for improvement without prior notice

PARA LIGHT